

Reference Specification

175°C Operation Leaded MLCC for Automotive with AEC-Q200 RHS Series

Product specifications in this catalog are as of Oct. 2018, and are subject to change or obsolescence without notice.

Please consult the approval sheet before ordering. Please read rating and Cautions first.

⚠ CAUTION

1. OPERATING VOLTAGE

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range. When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.

When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for each equipment should be taken into considerations.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage	Pulse Voltage(1)	Pulse Voltage(2)
Positional Measurement	Vo-p	Vo-p	Vp-p	Vp-p	Vp-p

2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss. In case of Class 2 capacitors (Temp.Char. : X7R,X7S,X8L, etc.), applied voltage should be the load such as self-generated heat is within 20 °C on the condition of atmosphere temperature 25 °C. Please contact us if self-generated heat is occurred with Class 1 capacitors (Temp.Char. : C0G,U2J,X8G, etc.). When measuring, use a thermocouple of small thermal capacity-K of ϕ 0.1mm and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability.

3. Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

4. OPERATING AND STORAGE ENVIRONMENT

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed 5 to 40 °C and 20 to 70%. Use capacitors within 6 months.

5. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

6. SOLDERING

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

7. BONDING AND RESIN MOLDING, RESIN COAT

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of a bonded or molded product in the intended equipment. In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive or molding resin may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

8. TREATMENT AFTER BONDING AND RESIN MOLDING, RESIN COAT

When the outer coating is hot (over 100 °C) after soldering, it becomes soft and fragile. So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9. LIMITATION OF APPLICATIONS

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

1. Aircraft equipment 2. Aerospace equipment

3. Undersea equipment 4. Power plant control equipment

5. Medical equipment6. Transportation equipment (vehicles, trains, ships, etc.)7. Traffic signal equipment8. Disaster prevention / crime prevention equipment

9. Data-processing equipment exerting influence on public

10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

NOTICE

1. CLEANING (ULTRASONIC CLEANING)

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time: 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. Soldering and Mounting

Insertion of the Lead Wire

- When soldering, insert the lead wire into the PCB without mechanically stressing the lead wire.
- Insert the lead wire into the PCB with a distance appropriate to the lead space.

3. CAPACITANCE CHANGE OF CAPACITORS

Class 2 capacitors (Temp.Char. : X7R,X7S,X8L, etc.)

Class 2 capacitors an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.

Please contact us if you need a detail information.

⚠ NOTE

- 1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. You are requested not to use our product deviating from this specification.

1. Application

This specification is applied to 175°C Operation Leaded MLCC RHS series in accordance with AEC-Q200 requirements used for Automotive Electronic equipment.

2. Rating

• Applied maximum temperature up to 175°C

Note: Maximum accumulative time to 175°C is within 2000 hours.

• Part number configuration

ex.)	RHS	N1	2A	103	K	0	A2	H01	В
	Series	Temperature	Rated	Capacitance	Capacitance	Dimension	Lead	Individual	Packing
		Characteristic	voltage		tolerance	code	code	specification	style
								code	code

Series

Code	Content
RHS	Epoxy coated, 175°C max.

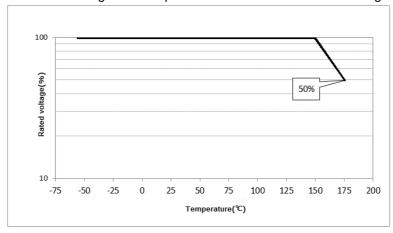
• Temperature characteristic

Code	Temp. Range	Cap. Change (Within%)	Standard Temp.	Operating Temp. Range
N1	-55 ∼ +125°C	+/-15	25°C	-55 ∼ +175°C
INI	+125~+175°C	+15/-60	25°C	-55~+175

• Rated voltage

Code	Rated voltage
2A	DC100V

When the product temperature exceeds 150°C, please use this product within the voltage and temperature derated conditions in the figure below.



Capacitance

The first two digits denote significant figures; the last digit denotes the multiplier of 10 in pF. ex.) In case of 103.

$$10 \times 10^3 = 10000 pF$$

• Capacitance tolerance

Code	Capacitance tolerance
K	+/-10%

• Dimension code

Code	Dimensions (LxW) mm max.
0	3.9 x 3.5
1	4.2 x 3.5
2	5.5 x 4.0

• Lead code

Code	Lead style	Lead spacing (mm)
A2	Straight type	2.5+/-0.8
DG	Straight taping type	2.5+0.4/-0.2
K1 Inside crimp type		5.0+/-0.8
M2	Inside crimp taping type	5.0+0.6/-0.2

Lead wire is solder coated CP wire.

Individual specification code
 Murata's control code
 Please refer to [Part number list].

• Packing style code

Code	Packing style
Α	Taping type of Ammo
В	Bulk type

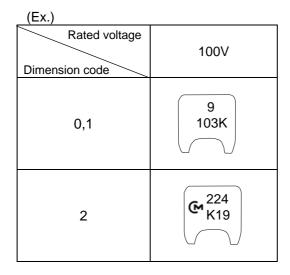
3. Marking

Temp. char. : Letter code : 9
Capacitance : 3 digit numbers

Capacitance tolerance : Code

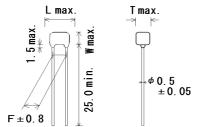
Rated voltage : Letter code : 1 (DC100V only. Except dimension code : 0,1)

Company name code : Abbreviation : (Except dimension code : 0,1)

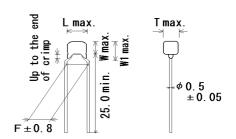


4. Part number list

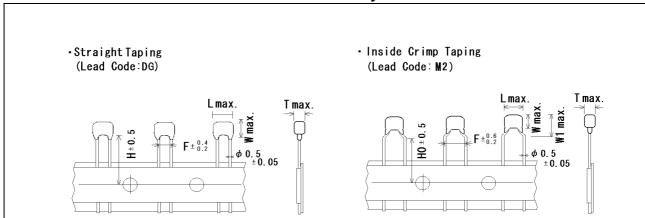
 Straight Long (Lead Code: A2)



Inside Crimp (Lead Code:K1)



				1							Jilit .	111111
Customer Part Number	Murata Part Number	T.C.	DC Rated	Cap.	Сар.		Dime	nsion	(mm)		Size Lead	Pacl
Customer Part Number	Murata Fart Number	1.0.	Volt. (V)	Сар.	tol.	L	W	W1	F	Т	Code	qty. (pcs
	RHSN12A472K0A2H01B	XAN	100	4700pF	±10%	3.9	3.5	-	2.5	2.6	0A2	500
	RHSN12A682K0A2H01B	XAN	100	6800pF	±10%	3.9	3.5		2.5	2.6	0A2	500
	RHSN12A103K0A2H01B	XAN	100	10000pF	±10%	3.9	3.5		2.5	2.6	0A2	500
	RHSN12A153K0A2H01B	XAN	100	15000pF	±10%	3.9	3.5		2.5	2.6	0A2	500
	RHSN12A223K0A2H01B	XAN	100	22000pF	±10%	3.9	3.5		2.5	2.6	0A2	500
	RHSN12A333K1A2H01B	XAN	100	33000pF	±10%	4.2	3.5		2.5	2.8	1A2	500
	RHSN12A473K1A2H01B	XAN	100	47000pF	±10%	4.2	3.5		2.5	2.8	1A2	500
	RHSN12A683K1A2H01B	XAN	100	68000pF	±10%	4.2	3.5		2.5	2.8	1A2	500
	RHSN12A104K1A2H01B	XAN	100	0.1µF	±10%	4.2	3.5		2.5	2.8	1A2	500
	RHSN12A154K2A2H01B	XAN	100	0.15µF	±10%	5.5	4.0		2.5	3.3	2A2	500
	RHSN12A224K2A2H01B	XAN	100	0.22µF	±10%	5.5	4.0		2.5	3.3	2A2	500
	RHSN12A472K0K1H01B	XAN	100	4700pF	±10%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHSN12A682K0K1H01B	XAN	100	6800pF	±10%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHSN12A103K0K1H01B	XAN	100	10000pF	±10%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHSN12A153K0K1H01B	XAN	100	15000pF	±10%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHSN12A223K0K1H01B	XAN	100	22000pF	±10%	3.9	3.5	6.0	5.0	2.6	0K1	500
	RHSN12A333K1K1H01B	XAN	100	33000pF	±10%	4.2	3.5	5.0	5.0	2.8	1K1	500
	RHSN12A473K1K1H01B	XAN	100	47000pF	±10%	4.2	3.5	5.0	5.0	2.8	1K1	500
	RHSN12A683K1K1H01B	XAN	100	68000pF	±10%	4.2	3.5	5.0	5.0	2.8	1K1	500
	RHSN12A104K1K1H01B	XAN	100	0.1µF	±10%	4.2	3.5	5.0	5.0	2.8	1K1	500
	RHSN12A154K2K1H01B	XAN	100	0.15µF	±10%	5.5	4.0	6.0	5.0	3.3	2K1	500
	RHSN12A224K2K1H01B	XAN	100	0.22µF	±10%	5.5	4.0	6.0	5.0	3.3	2K1	500



Customer Part Number	Murata Part Number	T.C.	DC Rated	Con	Can tal		Di	mensi	on (mr	m)		Size Lead	Pack
Customer Fait Number	Murata Fart Number	1.0.	volt. (V)	Cap.	Cap. tol.	L	W	W1	F	Т	H/H0	Code	qty. (pcs)
	RHSN12A472K0DGH01A	XAN	100	4700pF	±10%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHSN12A682K0DGH01A	XAN	100	6800pF	±10%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHSN12A103K0DGH01A	XAN	100	10000pF	±10%	3.9	3.5	,	2.5	2.6	20.0	0DG	2000
	RHSN12A153K0DGH01A	XAN	100	15000pF	±10%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHSN12A223K0DGH01A	XAN	100	22000pF	±10%	3.9	3.5	-	2.5	2.6	20.0	0DG	2000
	RHSN12A333K1DGH01A	XAN	100	33000pF	±10%	4.2	3.5	-	2.5	2.8	20.0	1DG	2000
	RHSN12A473K1DGH01A	XAN	100	47000pF	±10%	4.2	3.5	-	2.5	2.8	20.0	1DG	2000
	RHSN12A683K1DGH01A	XAN	100	68000pF	±10%	4.2	3.5	-	2.5	2.8	20.0	1DG	2000
	RHSN12A104K1DGH01A	XAN	100	0.1µF	±10%	4.2	3.5	-	2.5	2.8	20.0	1DG	2000
	RHSN12A154K2DGH01A	XAN	100	0.15µF	±10%	5.5	4.0	-	2.5	3.3	20.0	2DG	1500
	RHSN12A224K2DGH01A	XAN	100	0.22µF	±10%	5.5	4.0	-	2.5	3.3	20.0	2DG	1500
	RHSN12A472K0M2H01A	XAN	100	4700pF	±10%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHSN12A682K0M2H01A	XAN	100	6800pF	±10%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHSN12A103K0M2H01A	XAN	100	10000pF	±10%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHSN12A153K0M2H01A	XAN	100	15000pF	±10%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHSN12A223K0M2H01A	XAN	100	22000pF	±10%	3.9	3.5	6.0	5.0	2.6	20.0	0M2	2000
	RHSN12A333K1M2H01A	XAN	100	33000pF	±10%	4.2	3.5	5.0	5.0	2.8	20.0	1M2	2000
	RHSN12A473K1M2H01A	XAN	100	47000pF	±10%	4.2	3.5	5.0	5.0	2.8	20.0	1M2	2000
	RHSN12A683K1M2H01A	XAN	100	68000pF	±10%	4.2	3.5	5.0	5.0	2.8	20.0	1M2	2000
	RHSN12A104K1M2H01A	XAN	100	0.1µF	±10%	4.2	3.5	5.0	5.0	2.8	20.0	1M2	2000
	RHSN12A154K2M2H01A	XAN	100	0.15µF	±10%	5.5	4.0	6.0	5.0	3.3	20.0	2M2	1500
	RHSN12A224K2M2H01A	XAN	100	0.22µF	±10%	5.5	4.0	6.0	5.0	3.3	20.0	2M2	1500

Pre-and Post Electrical Tes ligh emperature exposure Storage)		No defects or abnormalities except color change of outer coating. within $\pm 12.5\%$ 0.04 max. More than $1,000M\Omega$ or $50~M\Omega\cdot\mu\text{F}$ (Whichever is smaller) No defects or abnormalities except color change of outer coating.	- Sit the capacitor for 1,000±12h at 175±5°C. Let sit for 24±2 *room condition , then measure. •Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min ar then let sit for 24±2 h at *room condition.
ligh emperature exposure Storage)	Appearance Capacitance Change D.F. I.R. Appearance Capacitance Change	change of outer coating. within $\pm 12.5\%$ 0.04 max. More than $1,000M\Omega$ or $50~M\Omega\cdot\mu F$ (Whichever is smaller) No defects or abnormalities except color	*room condition , then measure. •Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min ar
emperature	D.F. I.R. Appearance Capacitance Change	More than 1,000M Ω or 50 M Ω · μ F (Whichever is smaller) No defects or abnormalities except color	Perform the heat treatment at 150+0/-10°C for 60±5 min ar
	Appearance Capacitance Change	No defects or abnormalities except color	
, ,	Change	renande di dutei coatino.	Perform the 1,000 cycles according to the four heat treatment listed in the following table. Let sit for 24±2 h at *room concepts:
	D.F.	within ±12.5%	then measure. Step 1 2 3 4
	I.R.	0.05 max. 1,000MΩ or 50MΩ·μF min. (Whichever is smaller)	Temp. (°C) -55+0/-3 Room Temp. 175+5/-0 Room Temp. Time (min.) 15±3 1 15±3 1
Aciatura			•Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min ar then let sit for 24±2 h at *room condition.
Resistance	Appearance Capacitance	No defects or abnormalities within ±12.5%	Apply the 24h heat (25 to 65°C) and humidity (80 to 98%) treatment shown below, 10 consecutive times.
	Change D.F.	0.05 max.	Let sit for 24±2 h at *room condition, then measure. Temperature Humidity Humidity
Biased Humidity	Appearance Capacitance Change D.F. I.R.	500MΩ or 25MΩ·μF min. (Whichever is smaller) No defects or abnormalities within ±12.5% 0.05 max. 500MΩ or 25MΩ·μF min.	Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min ar then let sit for 24±2 h at *room condition. Apply the rated voltage and DC1.3+0.2/-0 V (add 100kΩ re at 85±3°C and 80 to 85% humidity for 1,000±12h. Remove and let sit for 24±2 h at *room condition, then mea The charge/discharge current is less than 50mA. Pretreatment Perform a heat treatment at 150+0/-10°C for 1hr.
	Appearance	No defects or abnormalities except color	and then set at room temperature for 24±2 hrs. Apply 50% of the rated voltage for 1,000±12h at 175±5°C. Let sit for 24±2 h at *room condition, then measure.
	Capacitance Change	within ±15.0%	The charge/discharge current is less than 50mA. •Pretreatment
	D.F. I.R.	0.04 max. 100M Ω or 5M Ω ·μF min.	Apply test voltage for 60±5 min at test temperature. Remove and let sit for 24±2 h at *room condition.
xternal Vieu	al	(Whichever is smaller) No defects or abnormalities	Visual inspection
hysical Dim		Within the specified dimensions	Using calipers and micrometers.
	Appearance	, ,	Visual inspection Per MIL-STD-202 Method 215
		Within the specified tolerance 0.025 max. More than 10,000M Ω or 500 M Ω - μ F (Whichever is smaller)	Solvent 1 : 1 part (by volume) of isopropyl alcohol 3 parts (by volume) of mineral spirits Solvent 2 : Terpene defluxer Solvent 3 : 42 parts (by volume) of water 1 part (by volume) of propylene glycol monomethyl ether 1 part (by volume) of monoethanolamine
3	iased lumidity perational ife xternal Visu hysical Dim larking esistance o Solvents	iased Change D.F. I.R. perational fe Change D.F. I.R. perational fe Capacitance Change D.F. I.R. perational Appearance Capacitance D.F. I.R. perational Inc.	Capacitance Change D.F. D.O.05 max.

No.	AEC- Test		Specification		AE	C-Q200 Test N	/lethod		
11 N	Mechanical	Appearance	No defects or abnormalities	Three shocks in each direction should be applied along 3					
S	Shock	Capacitance	Within the specified tolerance	mutually	mutually perpendicular axes of the test specimen (18 sh The specified test pulse should be Half-sine and should			shocks).	
		D.F.	0.025 max.	duration :0.5ms, peak value:1,500G and velocity change: 4.					
12 \	Vibration	Appearance	No defects or abnormalities	The capacitor should be subjected to a simple harmonic m					
		Capacitance	Within the specified tolerance	having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 2,000Hz. The frequency range, from 10 to 2,000Hz and return to 10Hz,					
		D.F.	0.025 max.						
				should be traversed in approximately 20 min. This motion should be applied for 12 items in each 3 mutually perpend directions (total of 36 times).				ion	
3-1 F	Resistance to Soldering Heat (Non- Preheat)	Appearance	No defects or abnormalities	The lead wires should be immersed in the melted solder 1.5 2.0mm from the root of terminal at 260±5°C for 10±1 seconds • Pre-treatment					
		Capacitance Change	Within ±7.5%						
		Dielectric	No defects						
F		Strength	110 40.00.0	Capacitor should be stored at 150+0/-10°C for one hour, then place at *room condition for 24±2 hours before					
		(Between						4±2 hours before	
		terminals)			measurement	=			
				Post-treatment					
3-2 F	Resistance	Appearance	No defects or abnormalities	Capacitor should be stored for 24±2 hours at *room condition First the capacitor should be stored at 120+0/-5°C for 60+0/-					
	o Soldering	Capacitance	Within ±7.5%	seconds. Then, the lead wires should be immersed in the melted sold					
ŀ	Heat (On-	Change							
,		Dielectric	No defects	1.5 to 2.0mm from the root of terminal at 260±5°C for 7.5+				7.5+0	
F	Preheat)	Strength		seconds	5.				
		(Between		• Pre-tre	atment				
		terminals)				stored at 150+	·0/-10°C for one	!	
				hour, then place at *room condition for 24±2 hours before initial measurement.					
					reatment		. h		
13-3 F	Resistance	Appearance	No defects or abnormalities	Capacitor should be stored for 24±2 hours at *room conditi Test condition					
	o Soldering	Capacitance	Within ±7.5%	Termperature of iron-tip: 350±10°C Soldering time: 3.5±0.5 seconds					
	Heat (soldering iron method)	Change	Within ±1.576						
		Dielectric	No defects	Soldering position Straight Lead:1.5 to 2.0mm from the root of terminal. Crimp Lead:1.5 to 2.0mm from the end of lead bend. • Pre-treatment Capacitor should be stored at 150+0/-10°C for one hour, then place at *room condition for 24±2 hours before initial measurement. • Post-treatment					
11		Strength							
		(Between							
		terminals)							
						stored for 24±2	hours at *room	conditi	
14 T	Thermal Shock	Appearance	No defects or abnormalities except color	Perform the 300 cycles according to the two heat treatme			nents li		
			change of outer coating.			laximum transfe		Let sit	
		Capacitance	within ±12.5%	24±2 h a		ion, then measu		_	
		Change	0.05 may	4	Step	1	2	_	
		D.F. I.R.	0.05 max. 1,000MΩ or 50MΩ·μF min.	1	Temp. (°C)	-55+0/-3	175+5/-0		
		1.1%	(Whichever is smaller)		Time	45:0	45.0	1	
			<u>'</u>	•D==4 · · ·	(min.)	15±3	15±3		
				•Pretreat		ment at 150+0/-1	10°C for 60±5 m	in and	
						at *room condition		and	
15 E	SD	Appearance	No defects or abnormalities	+	-Q200-002				
		Capacitance	Within the specified tolerance						
		D.F.	0.025 max.]					
		I.R.	More than 10,000M Ω or 500 M Ω ·μF (Whichever is smaller)						
16 5	Solderability		Lead wire should be soldered with uniform	The term	inal of a capa	citor is dipped in	to a solution of	ethanc	
			coating on the axial direction over 95% of the circumferential direction.	(JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight propotion) and then into molten solder (JIS-Z-3282) for 2 ± 0.5 (In both cases the depth of dipping is up to about 1.5 to 2mm f the terminal body.					
				uie teiilli	nai bouy.				
				Temp. of	solder:				
1			1			0-1-1(0 0.04-	0.50		
					C Lead Free :	Solder(Sn-3.0A) 33A Eutectic Sol	•		

				Reference	J,				
No.	_	AEC-Q200 Test Item		Specifications	AEC-Q200 Test Method				
17	Electrical	Apperance	No defects or abnormalities		Visual inspection.				
	Characte- rization	Capacitance	Within the specified tolerance		The capacitance/D.F. should be measured at 25°C at the frequency and voltage shown in the table.				
		D.F.	0.025 max.		Frequency Voltage				
					1±0.1kHz 1±0.2V(ms)				
		Insulation Resistance (I.R.)	Room Temperature	10,000M Ω or 500M Ω ·μF min. (Whichever is smaller)	The insulation resistance should be measured at 25±3 °C with DC voltage not exceeding the rated voltage at normal temperate and humidity and within 2 min. of charging. (Charge/Discharge current ≤ 50mA)				
			High Temperature	10MΩ or 0.5MΩ·μF min. (Whichever is smaller)	The insulation resistance should be measured at 175±5 °C with DC voltage not exceeding 50% of the rated voltage at normal temperature and humidity and within 2 min. of charging. (Charge/Discharge current ≤ 50mA)				
		Dielectric Strength	Between Terminals	No defects or abnormalities	The capacitor should not be damaged when DC voltage of 250 of the rated voltage is applied between the terminations for 1 to seconds.				
			Body Insulation	No defects or abnormalities	(Charge/Discharge current ≤ 50mA.) The capacitor is placed in a container with metal balls of 1mm diameter so that each terminal, short-circuit is kept approximately 2mm from the balls, and 250% of the rated DC voltage is impressed for 1 to 5 seconds between capacitor terminals and metal balls. (Charge/Discharge current ≤ 50mA.)				
18	Terminal Strength	Tensile Strength	Termination not to be broken or loosened Termination not to be broken or loosened		As in the figure, fix the capacitor body, apply the force gradual to each lead in the radial direction of the capacitor until reachir 10N and then keep the force applied for 10±1 seconds.				
		Bending Strength			Each lead wire should be subjected to a force of 2.5N and the be bent 90° at the point of egress in one direction. Each wire then returned to the original position and bent 90° in the oppodirection at the rate of one bend per 2 to 3 seconds.				
19	Capacitance Temperature Characteristics		-55 to 125°	specified Tolerance. C: within ±15% °C: within +15/-60%	The capacitance change should be measured after 5min. at each specified temperature step. Step Temperature(°C) 1 25±2 2 -55±3 3 25±2 4 175±5 5 25±2				
					The ranges of capacitance change compared with the above 25°C value over the temperature ranges shown in the table should be within the specified ranges. •Pretreatment Perform the heat treatment at 150+0/-10°C for 60±5 min and then let sit for 24±2 h at *room condition. Perform the initial measurement.				
"roon	n condition"	Temperature:1	5 to 35°C, Re	lative humidity:45 to 75%, Atmosph	nere pressure:86 to 106kPa				

6. Packing specification

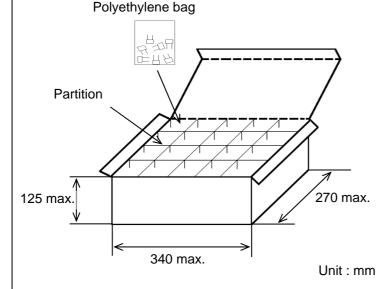
•Bulk type (Packing style code : B)

The size of packing case and packing way

The number of packing = *1 Packing quantity *2 n

*1 : Please refer to [Part number list].

*2 : Standard n = 20 (bag)

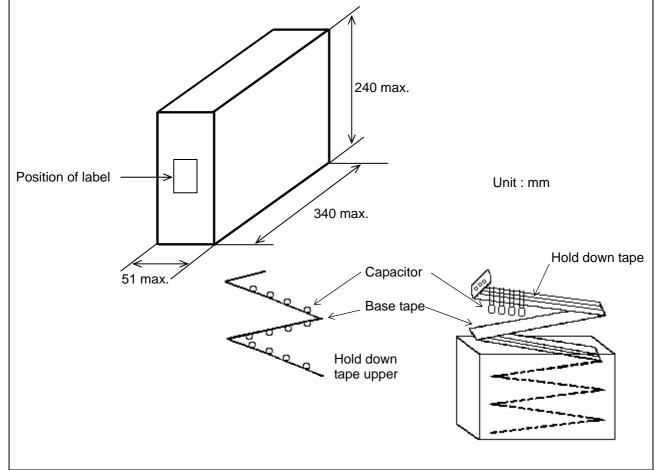


Note)

The outer package and the number of outer packing be changed by the order getting amount.

- •Ammo pack taping type (Packing style code : A)
 - · A crease is made every 25 pitches, and the tape with capacitors is packed zigzag into a case.
 - · When body of the capacitor is piled on other body under it.

The size of packing case and packing way

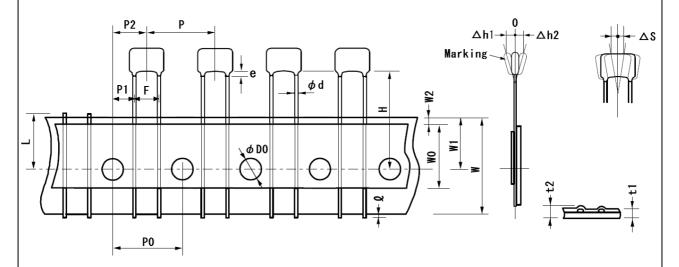


7. Taping specification

7-1. Dimension of capacitors on tape

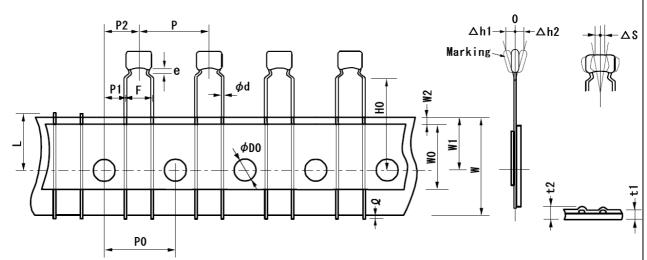
Straight taping type < Lead code : DG >

Pitch of component 12.7mm / Lead spacing 2.5mm



Item	Code	Dimensions	Remarks	
Pitch of component	Р	12.7+/-1.0		
Pitch of sprocket hole	P0	12.7+/-0.2		
Lead spacing	F	2.5+0.4/-0.2		
Length from hole center to component center	P2	6.35+/-1.3		
Length from hole center to lead	P1	5.1+/-0.7	Deviation of progress direction	
Deviation along tape, left or right defect	ΔS	0+/-2.0	They include deviation by lead bend .	
Carrier tape width	W	18.0+/-0.5		
Position of sprocket hole	W1	9.0+0/-0.5	Deviation of tape width direction	
Lead distance between reference and bottom plane	Н	20.0+/-0.5		
Protrusion length	l	0.5 max.		
Diameter of sprocket hole	D0	4.0+/-0.1		
Lead diameter	d	0.50+/-0.05		
Total tape thickness	t1	0.6+/-0.3		
Total thickness of tape and lead wire	t2	1.5 max.	They include hold down tape thickness.	
B	∆h1	1.0 max.		
Deviation across tape	∆h2	1.0 max.		
Portion to cut in case of defect	L	11.0+0/-1.0		
Hold down tape width	W0	9.5 min.		
Hold down tape position	W2	1.5+/-1.5		
Coating extension on lead	е	1.5 max.		

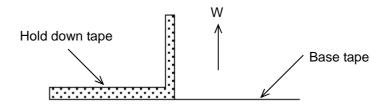
Inside crimp taping type < Lead code : M2 > Pitch of component 12.7mm / Lead spacing 5.0mm



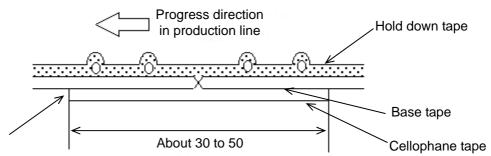
Item	Code	Dimensions	Remarks	
Pitch of component	Р	12.7+/-1.0		
Pitch of sprocket hole	P0	12.7+/-0.2		
Lead spacing	F	5.0+0.6/-0.2		
Length from hole center to component center	P2	6.35+/-1.3	Deviation of programs dispation	
Length from hole center to lead	P1	3.85+/-0.7	Deviation of progress direction	
Deviation along tape, left or right defect	ΔS	0+/-2.0	They include deviation by lead bend .	
Carrier tape width	W	18.0+/-0.5		
Position of sprocket hole	W1	9.0+0/-0.5	Deviation of tape width direction	
Lead distance between reference and bottom plane	НО	20.0+/-0.5		
Protrusion length	l	0.5 max.		
Diameter of sprocket hole	D0	4.0+/-0.1		
Lead diameter	φd	0.50+/-0.05		
Total tape thickness	t1	0.6+/-0.3		
Total thickness of tape and lead wire	t2	1.5 max.	They include hold down tape thickness.	
Deviation agrees to a	∆h1	2.0 max. (Dimension code : W)		
Deviation across tape	∆h2	1.0 max. (except as above)		
Portion to cut in case of defect	L	11.0+0/-1.0		
Hold down tape width	W0	9.5 min.		
Hold down tape position	W2	1.5+/-1.5		
Coating extension on lead	е	Up to the end of c	rimp	

7-2. Splicing way of tape

1) Adhesive force of tape is over 3N at test condition as below.



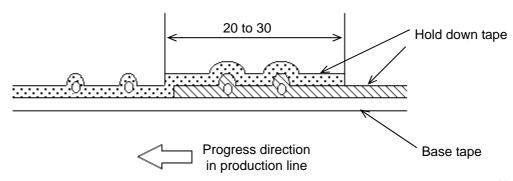
- 2) Splicing of tape
 - a) When base tape is spliced
 - •Base tape shall be spliced by cellophane tape. (Total tape thickness shall be less than 1.05mm.)



No lifting for the direction of progressing

Unit: mm

- b) When hold down tape is spliced
 - •Hold down tape shall be spliced with overlapping. (Total tape thickness shall be less than 1.05mm.)



- c) When both tape are spliced
 - •Base tape and hold down tape shall be spliced with splicing tape.

EU RoHS and Halogen Free

This products of the following crresponds to EU RoHS and Halogen Free

(1) RoHS

EU RoHs 2011/65/EC compliance

maximum concentration values tolerated by weight in homogeneous materials

- •1000 ppm maximum Lead
- •1000 ppm maximum Mercury
- •100 ppm maximum Cadmium
- •1000 ppm maximum Hexavalent chromium
- •1000 ppm maximum Polybrominated biphenyls (PBB)
- •1000 ppm maximum Polybrominated diphenyl ethers (PBDE)

(2) Halogen-Free

The International Electrochemical Commission's (IEC) Definition of Halogen-Free (IEC 61249-2-21) compliance

- •900 ppm maximum chlorine
- •900 ppm maximum bromine
- •1500 ppm maximum total chlorine and bromine

Mouser Electronics

Authorized Distributor

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Murata:

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        RHSN12A223K0A2H01B
        RHSN12A682K0A2H01B
        RHSN12A104K1DGH01A
        RHSN12A224K2K1H01B

        RHSN12A154K2DGH01A
        RHSN12A472K0K1H01B
        RHSN12A154K2A2H01B
        RHSN12A224K2DGH01A

        RHSN12A223K0K1H01B
        RHSN12A683K1A2H01B
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